

SURE

CLEMSON
UNIVERSITY

**2021 Summer Undergraduate Research Experience (SURE) in Solid-State
Devices for Electronics, Photonics, and Magnetics Technology**

Application Form

Start date: May 17, 2021 End date: July 23, 2021

Priority will be given to applications received by March 5, 2021.

Early applications may receive early consideration.

All applicants will be notified of their status no later than April 9, 2021.

For more information, please contact: aleslie@clermson.edu

Full Name

Street Address

City

State

Zip

Phone

Email

University/Institution:

Expected Graduation Date (Month/Year):

Major:

Minor:

Present Grade Point Average: (A minimum GPA of 3.0 out of 4.0 is required)

US Citizen/Permanent resident: Yes ___ No ___ (US citizenship or permanent-resident status is required.)

Date of Birth (MM/DD/YYYY):

Gender:

Racial/Ethnic Category:

Research Interests (e.g. Materials, Devices, Circuits, related to Electronics, Photonics, or Magnetics):

Other requested information for application:

- Transcripts of all college courses (can be unofficial)
- Resume
- Brief Statement of research interests and goals
- We strongly encourage applicants to obtain one or two letters of recommendation from faculty members. Strong letters of recommendation can strengthen the application

To apply, please submit this form and supplemental materials via email to aleslie@clermson.edu, or mail to:

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SURE c/o Amanda Harris
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